

5.0 kV rms Dual Channel Digital Isolators

FEATURES

- ▶ High common-mode transient immunity: 100 kV/μs
- ▶ High robustness to radiated and conducted noise
- ▶ Low propagation delay: 13 ns maximum for 5 V operation, 15 ns maximum for 1.8 V operation
- ▶ 150 Mbps maximum data rate
- ▶ Safety and regulatory approvals
 - ▶ RW-16 [SOIC_W] package
 - ▶ UL 1577
 - ▶ $V_{ISO} = 5000$ V rms for 1 minute
 - ▶ IEC/EN/CSA 62368-1
 - ▶ IEC/CSA 60601-1
 - ▶ IEC/CSA 61010-1
 - ▶ CQC GB 4943.1
 - ▶ DIN EN IEC 60747-17 (VDE 0884-17)
 - ▶ $V_{IORM} = 849$ V peak
 - ▶ RI-8 [SOIC_IC] package
 - ▶ UL 1577
 - ▶ $V_{ISO} = 5000$ V rms for 1 minute
 - ▶ IEC/EN/CSA 62368-1
 - ▶ IEC/CSA 60601-1
 - ▶ IEC/CSA 61010-1
 - ▶ CQC GB 4943.1 (pending)
 - ▶ DIN EN IEC 60747-17 (VDE 0884-17)
 - ▶ $V_{IORM} = 849$ V peak
- ▶ Low dynamic power consumption
- ▶ 1.8 V to 5 V level translation
- ▶ High temperature operation: 125°C maximum
- ▶ Fail-safe high or low options
- ▶ 8-lead/16-lead, RoHS compliant SOIC packages
- ▶ AEC-Q100 qualified for automotive applications

APPLICATIONS

- ▶ General-purpose multichannel isolation
- ▶ Industrial field bus isolation
- ▶ Automotive systems

GENERAL DESCRIPTION

The ADuM220N/ADuM221N/ADuM225N/ADuM226N¹ are dual-channel digital isolators based on Analog Devices, Inc., iCoupler® technology. Combining high speed, complementary metal-oxide semiconductor (CMOS) and monolithic air core transformer technology, these isolation components provide outstanding performance characteristics superior to alternatives such as optocoupler devices and other integrated couplers. The maximum propagation delay is 13 ns with a pulse width distortion (PWD) of less than 3 ns at 5 V operation. Channel matching is tight at 3.0 ns maximum.

The ADuM220N/ADuM221N/ADuM225N/ADuM226N data channels are independent and are available in a variety of configurations with a withstand voltage rating of 5.0 kV rms (see the [Ordering Guide](#)). The devices operate with the supply voltage on either side ranging from 1.8 V to 5 V, providing compatibility with lower voltage systems as well as enabling voltage translation functionality across the isolation barrier. Unlike other optocoupler alternatives, dc correctness is ensured in the absence of input logic transitions. Two different fail-safe options are available, in which the outputs transition to a predetermined state when the input power supply is not applied or the inputs are disabled. The ADuM220N0 is pin compatible with the [ADuM2210](#) RW-16 package. The ADuM220N1 is pin compatible with the [ADuM2200](#) RW-16 package. The ADuM221N0 is pin compatible with the [ADuM2211](#) RW-16 package. The ADuM221N1 is pin compatible with the [ADuM2201](#) RW-16 package.

¹ Protected by U.S. Patents 5,952,849; 6,873,065; 6,903,578; and 7,075,329. Other patents are pending.

TABLE OF CONTENTS

Features.....	1	Maximum Continuous Working Voltage.....	14
Applications.....	1	Truth Table.....	14
General Description.....	1	Pin Configurations and Function Descriptions.....	15
Functional Block Diagrams.....	3	Typical Performance Characteristics.....	18
Specifications.....	4	Theory of Operation.....	19
Electrical Characteristics—5 V Operation.....	4	Overview.....	19
Electrical Characteristics—3.3 V Operation.....	5	Applications Information.....	20
Electrical Characteristics—2.5 V Operation.....	7	PCB Layout.....	20
Electrical Characteristics—1.8 V Operation.....	8	Propagation Delay Related Parameters.....	20
Insulation and Safety Related Specifications...	10	Jitter Measurement.....	20
Package Characteristics.....	11	Insulation Lifetime.....	20
Regulatory Information.....	11	Outline Dimensions.....	22
DIN EN IEC 60747-17 (VDE 0884-17)		Ordering Guide.....	22
Insulation Characteristics.....	12	No. of Inputs, V_{DD1} and V_{DD2} Side Options.....	23
Recommended Operating Conditions.....	13	Withstand Voltage Rating (kV rms) and Fail-Safe Output State Options.....	24
Absolute Maximum Ratings.....	14	Automotive Products.....	24
ESD Caution.....	14		

REVISION HISTORY**12/2024—Rev. C to Rev. D**

Changes to Features Section.....	1
Changes to Table 9 and Table 10.....	10
Changes to Regulatory Information Section, Table 13, and Table 14.....	11
Changed DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics Section to DIN EN IEC 60747-17 (VDE 0884-17) Insulation Characteristics Section.....	12
Changes to Table 15, Figure 5 Caption, and Figure 6 Caption.....	12
Changes to Table 18 and Table 19.....	14
Changes to Calculation and Use of Parameters Example Section.....	21

12/2023—Rev. B to Rev. C

Changes to Features Section.....	1
Changes to Table 13.....	11
Changes to Table 14.....	11
Added No. of Inputs, V_{DD1} and V_{DD2} Side Options Section.....	23
Added Withstand Voltage Rating (kV rms) and Fail-Safe Output State Options Section.....	24

FUNCTIONAL BLOCK DIAGRAMS

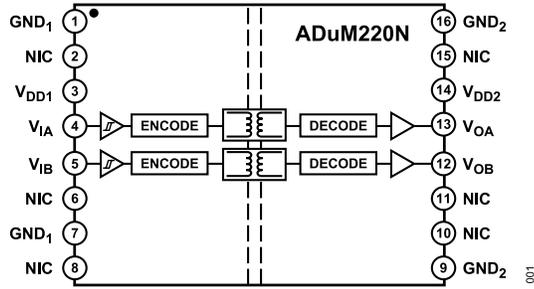


Figure 1.

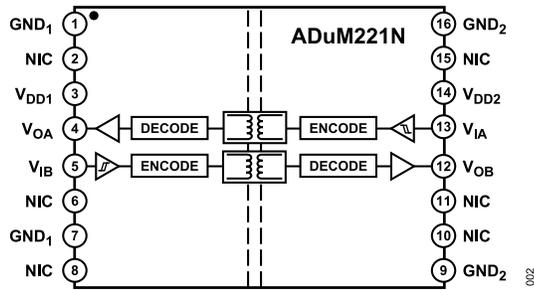


Figure 2.

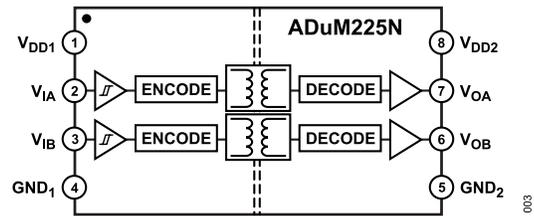


Figure 3.

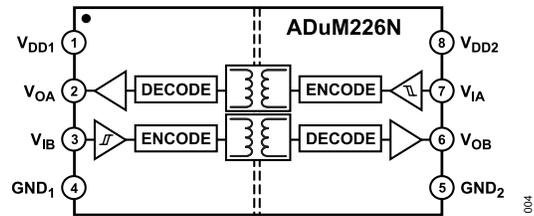


Figure 4.

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range of $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$, $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 1.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within pulse width distortion (PWD) limit
Data Rate		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	4.8	7.2	13	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.5	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/ $^\circ\text{C}$	
Propagation Delay Skew	t_{PSK}			6.0	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.5	3.0	ns	
Opposing Direction	t_{PSKOD}		0.5	3.0	ns	
Jitter			380		ps p-p	See the Jitter Measurement section
			55		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^1 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^2$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^1 = -4\ \text{mA}$, $V_{Ix} = V_{IxH}^2$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^1 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^3$
			0.2	0.4	V	$I_{Ox}^1 = 4\ \text{mA}$, $V_{Ix} = V_{IxL}^3$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
Quiescent Supply Current						
ADuM220N/ADuM225N						
	$I_{DD1(Q)}$		0.9	1.3	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD2(Q)}$		1.3	1.8	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD1(Q)}$		6.4	10.0	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
	$I_{DD2(Q)}$		1.4	1.9	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
ADuM221N/ADuM226N						
	$I_{DD1(Q)}$		1.1	1.6	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD2(Q)}$		1.1	1.5	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD1(Q)}$		4.0	5.8	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
	$I_{DD2(Q)}$		4.9	6.4	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
Dynamic Supply Current						
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Dynamic Output	$I_{DDO(D)}$		0.02		mA/Mbps	Inputs switching, 50% duty cycle
Undervoltage Lockout	UVLO					
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%

SPECIFICATIONS

Table 1. (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Common-Mode Transient Immunity ⁶	CM _H	75	100		kV/μs	V _{Ix} = V _{DDx} , V _{CM} = 1000 V, transient magnitude = 800 V
	CM _L	75	100		kV/μs	V _{Ix} = 0 V, V _{CM} = 1000 V, transient magnitude = 800 V

¹ I_{Ox} is the Channel x output current, where x is A or B.

² V_{IxH} is the input side logic high.

³ V_{IxL} is the input side logic low.

⁴ V_I is the voltage input.

⁵ N0 refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the [Ordering Guide](#) section.

⁶ |CM_H| is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_O) > 0.8 V_{DDx}. |CM_L| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 2. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM220N/ADuM225N											
Supply Current Side 1	I _{DD1}		3.7	6.8		4.2	7.2		6.2	9.3	mA
Supply Current Side 2	I _{DD2}		1.4	2.0		2.2	3.2		4.8	8.1	mA
ADuM221N/ADuM226N											
Supply Current Side 1	I _{DD1}		2.6	4.5		3.2	5.4		5.4	8.2	mA
Supply Current Side 2	I _{DD2}		3.0	4.9		3.7	5.9		5.9	8.6	mA

ELECTRICAL CHARACTERISTICS—3.3 V OPERATION

All typical specifications are at T_A = 25°C, V_{DD1} = V_{DD2} = 3.3 V. Minimum/maximum specifications apply over the entire recommended operation range: 3.0 V ≤ V_{DD1} ≤ 3.6 V, 3.0 V ≤ V_{DD2} ≤ 3.6 V, and -40°C ≤ T_A ≤ +125°C, unless otherwise noted. Switching specifications are tested with C_L = 15 pF and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 3.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within PWD limit
Data Rate		150			Mbps	Within PWD limit
Propagation Delay	t _{PHL} , t _{PLH}	4.8	6.8	14	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.7	3	ns	t _{PLH} - t _{PHL}
Change vs. Temperature			1.5		ps/°C	
Propagation Delay Skew	t _{PSK}			7.0	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t _{PSKCD}		0.7	3.0	ns	
Opposing Direction	t _{PSKOD}		0.7	3.0	ns	
Jitter			290		ps p-p	See the Jitter Measurement section
			45		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold						
Logic High	V _{IH}	0.7 × V _{DDx}			V	
Logic Low	V _{IL}			0.3 × V _{DDx}	V	

SPECIFICATIONS

Table 3. (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^1 = -20 \mu A$, $V_{ix} = V_{ixH}^2$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^1 = -2 \text{ mA}$, $V_{ix} = V_{ixH}^2$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^1 = 20 \mu A$, $V_{ix} = V_{ixL}^3$
			0.2	0.4	V	$I_{Ox}^1 = 2 \text{ mA}$, $V_{ix} = V_{ixL}^3$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0 \text{ V} \leq V_{ix} \leq V_{DDx}$
Quiescent Supply Current						
ADuM220N/ADuM225N	$I_{DD1(Q)}$		0.8	1.3	mA	$V_I^4 = 0$ (N0), 1 (N1) ⁵
	$I_{DD2(Q)}$		1.2	1.8	mA	$V_I^4 = 0$ (N0), 1 (N1) ⁵
	$I_{DD1(Q)}$		6.3	9.7	mA	$V_I^4 = 1$ (N0), 0 (N1) ⁵
	$I_{DD2(Q)}$		1.3	1.8	mA	$V_I^4 = 1$ (N0), 0 (N1) ⁵
ADuM221N/ADuM226N	$I_{DD1(Q)}$		1.0	1.6	mA	$V_I^4 = 0$ (N0), 1 (N1) ⁵
	$I_{DD2(Q)}$		1.0	1.5	mA	$V_I^4 = 0$ (N0), 1 (N1) ⁵
	$I_{DD1(Q)}$		3.9	5.8	mA	$V_I^4 = 1$ (N0), 0 (N1) ⁵
	$I_{DD2(Q)}$		4.8	6.4	mA	$V_I^4 = 1$ (N0), 0 (N1) ⁵
Dynamic Supply Current						Inputs switching, 50% duty cycle
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	
Dynamic Output	$I_{DDO(D)}$		0.01		mA/Mbps	
Undervoltage Lockout	UVLO					
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁶	$ CM_H $	75	100		kV/ μs	$V_{ix} = V_{DDx}$, $V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μs	$V_{ix} = 0 \text{ V}$, $V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V

¹ I_{Ox} is the Channel x output current, where x is A or B.

² V_{ixH} is the input side logic high.

³ V_{ixL} is the input side logic low.

⁴ V_I is the voltage input.

⁵ N0 refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the [Ordering Guide](#) section.

⁶ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DDx}$. $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 \text{ V}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 4. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM220N/ADuM225N											
Supply Current Side 1	I_{DD1}		3.6	6.2		4.0	6.7		5.6	9.1	mA
Supply Current Side 2	I_{DD2}		1.3	1.9		2.1	3.1		4.4	6.8	mA

SPECIFICATIONS

Table 4. Total Supply Current vs. Data Throughput (Continued)

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
ADuM221N/ADuM226N											
Supply Current Side 1	I_{DD1}		2.5	4.6		3.0	5.5		5.0	8.1	mA
Supply Current Side 2	I_{DD2}		2.9	4.8		3.5	5.8		5.4	8.3	mA

ELECTRICAL CHARACTERISTICS—2.5 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 2.5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $2.25\text{ V} \leq V_{DD1} \leq 2.75\text{ V}$, $2.25\text{ V} \leq V_{DD2} \leq 2.75\text{ V}$, $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 5.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within PWD limit
Data Rate		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	5.0	7.0	14	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.7	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/ $^\circ\text{C}$	
Propagation Delay Skew	t_{PSK}			7.0	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.7	3.0	ns	
Opposing Direction	t_{PSKOD}		0.7	3.0	ns	
Jitter			320		ps p-p	See the Jitter Measurement section
			65		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^1 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^2$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^1 = -2\ \text{mA}$, $V_{Ix} = V_{IxH}^2$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^1 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^3$
			0.2	0.4	V	$I_{Ox}^1 = 2\ \text{mA}$, $V_{Ix} = V_{IxL}^3$
Input Current per Channel	I_I	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
Quiescent Supply Current						
ADuM220N/ADuM225N						
	$I_{DD1(Q)}$		0.8	1.2	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD2(Q)}$		1.2	1.8	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD1(Q)}$		6.2	9.5	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
	$I_{DD2(Q)}$		1.3	1.8	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
ADuM221N/ADuM226N						
	$I_{DD1(Q)}$		1.0	1.5	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD2(Q)}$		1.0	1.4	mA	$V_I^4 = 0\ (N0)$, $1\ (N1)^5$
	$I_{DD1(Q)}$		3.9	5.8	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
	$I_{DD2(Q)}$		4.8	6.4	mA	$V_I^4 = 1\ (N0)$, $0\ (N1)^5$
Dynamic Supply Current						
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle

SPECIFICATIONS

Table 5. (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Dynamic Output Undervoltage Lockout	$I_{DDO(D)}$		0.01		mA/Mbps	
Positive V_{DDX} Threshold	V_{DDXUV+}		1.6		V	
Negative V_{DDX} Threshold	V_{DDXUV-}		1.5		V	
V_{DDX} Hysteresis	V_{DDXUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁶	$ CM_H $	75	100		kV/ μ s	$V_{IX} = V_{DDX}$, $V_{CM} = 1000$ V, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μ s	$V_{IX} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V

¹ I_{Ox} is the Channel x output current, where x is A or B.

² V_{IXH} is the input side logic high.

³ V_{IXL} is the input side logic low.

⁴ V_I is the voltage input.

⁵ N0 refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the [Ordering Guide](#) section.

⁶ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DDX}$. $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 6. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM220N/ADuM225N											
Supply Current Side 1	I_{DD1}		3.5	6.2		3.9	6.6		5.4	9.0	mA
Supply Current Side 2	I_{DD2}		1.3	1.9		1.9	2.8		3.6	5.8	mA
ADuM221N/ADuM226N											
Supply Current Side 1	I_{DD1}		2.4	4.7		2.9	5.5		4.5	8.0	mA
Supply Current Side 2	I_{DD2}		2.9	4.9		3.3	5.7		4.9	7.7	mA

ELECTRICAL CHARACTERISTICS—1.8 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 1.8$ V. Minimum/maximum specifications apply over the entire recommended operation range: $1.7\text{ V} \leq V_{DD1} \leq 1.9\text{ V}$, $1.7\text{ V} \leq V_{DD2} \leq 1.9\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15$ pF and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 7.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within PWD limit
Data Rate		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	5.8	8.7	15	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.7	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/ $^\circ\text{C}$	
Propagation Delay Skew	t_{PSK}			7.0	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.7	3.0	ns	

SPECIFICATIONS

Table 7. (Continued)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Opposing Direction Jitter	t_{PSKOD}		0.7	3.0	ns	
			630		ps p-p	See the Jitter Measurement section
			190		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^1 = -20 \mu A, V_{Ix} = V_{IxH}^2$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^1 = -2 \text{ mA}, V_{Ix} = V_{IxH}^2$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^1 = 20 \mu A, V_{Ix} = V_{IxL}^3$
			0.2	0.4	V	$I_{Ox}^1 = 2 \text{ mA}, V_{Ix} = V_{IxL}^3$
Input Current per Channel	I_i	-10	+0.01	+10	μA	$0 \text{ V} \leq V_{Ix} \leq V_{DDx}$
Quiescent Supply Current						
ADuM220N/ADuM225N						
	$I_{DD1} (Q)$		0.7	1.2	mA	$V_i^4 = 0 (N0), 1 (N1)^5$
	$I_{DD2} (Q)$		1.2	1.8	mA	$V_i^3 = 0 (N0), 1 (N1)^5$
	$I_{DD1} (Q)$		6.2	9.6	mA	$V_i^3 = 1 (N0), 0 (N1)^5$
	$I_{DD2} (Q)$		1.3	1.8	mA	$V_i^4 = 1 (N0), 0 (N1)^5$
ADuM221N/ADuM226N						
	$I_{DD1} (Q)$		1.0	1.5	mA	$V_i^4 = 0 (N0), 1 (N1)^5$
	$I_{DD2} (Q)$		1.0	1.4	mA	$V_i^4 = 0 (N0), 1 (N1)^5$
	$I_{DD1} (Q)$		3.8	5.8	mA	$V_i^4 = 1 (N0), 0 (N1)^5$
	$I_{DD2} (Q)$		4.7	6.4	mA	$V_i^4 = 1 (N0), 0 (N1)^5$
Dynamic Supply Current						Inputs switching, 50% duty cycle
Dynamic Input	$I_{DDI} (D)$		0.01		mA/Mbps	
Dynamic Output	$I_{DDO} (D)$		0.01		mA/Mbps	
Undervoltage Lockout	UVLO					
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁶	$ CM_H $	75	100		kV/ μs	$V_{Ix} = V_{DDx}, V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μs	$V_{Ix} = 0 \text{ V}, V_{CM} = 1000 \text{ V}$, transient magnitude = 800 V

¹ I_{Ox} is the Channel x output current, where x is A or B.

² V_{IxH} is the input side logic high.

³ V_{IxL} is the input side logic low.

⁴ V_i is the voltage input.

⁵ N0 refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the [Ordering Guide](#) section.

⁶ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DDx}$. $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 \text{ V}$. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

SPECIFICATIONS

Table 8. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM220N/ADuM225N											
Supply Current Side 1	I_{DD1}		3.4	6.0		3.8	6.4		5.2	8.4	mA
Supply Current Side 2	I_{DD2}		1.2	1.8		1.8	2.8		3.6	5.8	mA
ADuM221N/ADuM226N											
Supply Current Side 1	I_{DD1}		2.4	4.7		2.8	5.5		4.4	7.8	mA
Supply Current Side 2	I_{DD2}		2.8	4.8		3.2	5.6		4.8	7.9	mA

INSULATION AND SAFETY RELATED SPECIFICATIONS

For additional information, see www.analog.com/icouplersafety.

Table 9. ADuM220N/ADuM221N

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		5000	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L (I01)	7.8 ^{1,2}	mm	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L (I02)	7.8	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance)	L (PCB)	8.3	mm	Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane
Minimum Internal Gap (Internal Clearance)		29	μm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		Material Group per IEC 60664-1

¹ In accordance with IEC 62368-1/IEC 60601-1 guidelines for the measurement of creepage and clearance distances for a pollution degree of 2 and altitudes ≤2000 meters.

² Consideration must be given to pad layout to ensure the minimum required distance for clearance is maintained.

Table 10. ADuM225N/ADuM226N

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		5000	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L (I01)	8.3 ^{1,2}	mm	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L (I02)	8.3	mm	Measured from input terminals to output terminals, shortest distance path along body
Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance)	L (PCB)	8.3	mm	Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane
Minimum Internal Gap (Internal Clearance)		29	μm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		Material Group per IEC 60664-1

¹ In accordance with IEC 62368-1/IEC 60601-1 guidelines for the measurement of creepage and clearance distances for a pollution degree of 2 and altitudes ≤2000 meters.

² Consideration must be given to pad layout to ensure the minimum required distance for clearance is maintained.

SPECIFICATIONS

PACKAGE CHARACTERISTICS

Table 11. ADuM220N/ADuM221N

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Resistance (Input to Output) ¹	R _{I-O}		10 ¹³		Ω	
Capacitance (Input to Output) ¹	C _{I-O}		2.2		pF	f = 1 MHz
Input Capacitance ²	C _I		4.0		pF	
IC Junction to Ambient Thermal Resistance	θ _{JA}		45		°C/W	Thermocouple located at center of package underside

¹ These devices are considered 2-terminal devices: Pin 1 through Pin 8 are shorted together, and Pin 9 through Pin 16 are shorted together.

² Input capacitance is from any input data pin to ground.

Table 12. ADuM225N/ADuM226N

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Resistance (Input to Output) ¹	R _{I-O}		10 ¹³		Ω	
Capacitance (Input to Output) ¹	C _{I-O}		2.2		pF	f = 1 MHz
Input Capacitance ²	C _I		4.0		pF	
IC Junction to Ambient Thermal Resistance	θ _{JA}		80		°C/W	Thermocouple located at center of package underside

¹ These devices are considered 2-terminal devices: Pin 1 through Pin 4 are shorted together, and Pin 5 through Pin 8 are shorted together.

² Input capacitance is from any input data pin to ground.

REGULATORY INFORMATION

The ADuM220N/ADuM221N certification approvals are listed in Table 13.

Table 13. ADuM220N/ADuM221N Regulatory Information

UL	CSA	VDE	CQC
UL 1577 ¹ Single Protection, 5000 V rms	IEC/EN/CSA 62368-1 Basic insulation, 780 V rms Reinforced insulation, 390 V rms IEC/CSA 60601-1 Basic insulation (1 MOPP), 490 V rms Reinforced insulation (2 MOPP), 50 V rms IEC/CSA 61010-1 Basic insulation, 600 V rms, overvoltage category III Reinforced insulation, 300 V rms	DIN EN IEC 60747-17 (VDE 0884-17) ² Reinforced insulation, 849 V peak	CQC GB 4943.1 Basic insulation, 780 V rms Reinforced insulation, 389 V rms
File E214100	File No. 205078	Certificate No. 40051926	Certificate No. CQC16001160971

¹ In accordance with UL 1577, each ADuM220N/ADuM221N is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 sec.

² In accordance with DIN EN IEC 60747-17 (VDE 0884-17), each ADuM220N/ADuM221N is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC).

The ADuM225N/ADuM226N certification approvals are listed in Table 14.

Table 14. ADuM225N/ADuM226N Regulatory Information

UL	CSA	VDE (Pending)	CQC (Pending)
UL 1577 ¹ Single Protection, 5000 V rms	IEC/EN/CSA 62368-1 Basic insulation, 830 V rms Reinforced insulation, 415 V rms IEC/CSA 60601-1	DIN EN IEC 60747-17 (VDE 0884-17) ² Reinforced insulation, 849 V peak	CQC GB 4943.1 Basic insulation, 800 V rms Reinforced insulation, 400 V rms

SPECIFICATIONS

Table 14. ADuM225N/ADuM226N Regulatory Information (Continued)

UL	CSA	VDE (Pending)	CQC (Pending)
File E214100	Basic insulation (1 MOPP), 519 V rms Reinforced insulation (2 MOPP), 50 V rms IEC/CSA 61010-1 Basic insulation, 600 V rms, overvoltage category IV Reinforced insulation, 300 V rms File No. 205078	Certificate No. (pending)	File (pending)

¹ In accordance with UL 1577, each ADuM225N/ADuM226N is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 sec.

² In accordance with DIN EN IEC 60747-17 (VDE 0884-17), each ADuM225N/ADuM226N is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC).

DIN EN IEC 60747-17 (VDE 0884-17) INSULATION CHARACTERISTICS

These ADuM220N/ADuM221N/ADuM225N/ADuM226N isolators are suitable for reinforced electrical isolation only within the safety limit data. Protective circuits ensure the maintenance of the safety data. The * marking on packages denotes DIN V VDE V 0884-10 approval.

Table 15.

Description	Test Conditions/Comments	Symbol	Characteristic	Unit
Overvoltage Category per IEC 60664-1 For Rated Mains Voltage ≤ 150 V rms For Rated Mains Voltage ≤ 300 V rms For Rated Mains Voltage ≤ 600 V rms			I to IV I to IV I to IV	
Climatic Classification			40/105/21	
Pollution Degree per DIN VDE 0110, Table 1			2	
Maximum Repetitive Isolation Voltage		V_{IORM}	849	V peak
Maximum Working Insulation Voltage		V_{IOWM}	600	V peak
Input to Output Test Voltage, Method B1	$V_{IORM} \times 1.875 = V_{pd(m)}$, 100% production test, $t_{ini} = t_m = 1$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1592	V peak
Input to Output Test Voltage, Method A After Environmental Tests Subgroup 1	$V_{IORM} \times 1.6 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1358	V peak
After Input and/or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1019	V peak
Maximum Transient Isolation Voltage ADuM220N/ADuM221N	$V_{TEST} = 1.2 \times V_{IOTM}$, $t = 1$ s (100% production)	V_{IOTM}	7000	V peak
ADuM225N/ADuM226N		V_{IOTM}	8000	V peak
Maximum Impulse Voltage ADuM220N/ADuM221N	Surge voltage in air, waveform per IEC 61000-4-5	V_{IMP}	7000	V peak
ADuM225N/ADuM226N		V_{IMP}	8000	V peak
Maximum Surge Isolation Voltage	$V_{TEST} \geq 1.3 \times V_{IMP}$ (sample test), tested in oil, waveform per IEC 61000-4-5	V_{IOSM}	10000	V peak
Safety Limiting Values	Maximum value allowed in the event of a failure (see Figure 5 or Figure 6)			
Maximum Junction Temperature		T_S	150	°C
Total Power Dissipation at 25°C ADuM220N/ADuM221N		P_S	2.78	W
ADuM225N/ADuM226N			1.56	W
Insulation Resistance at T_S	$V_{IO} = 500$ V	R_S	$>10^9$	Ω

SPECIFICATIONS

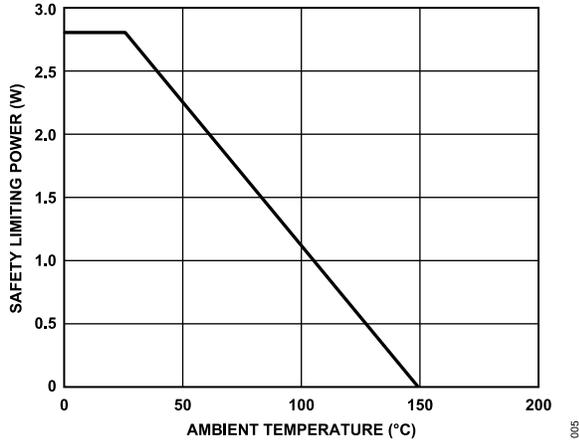


Figure 5. ADuM220N/ADuM221N Thermal Derating Curve, Dependence of Safety Limiting Values with Ambient Temperature per DIN EN IEC 60747-17 (VDE 0884-17)

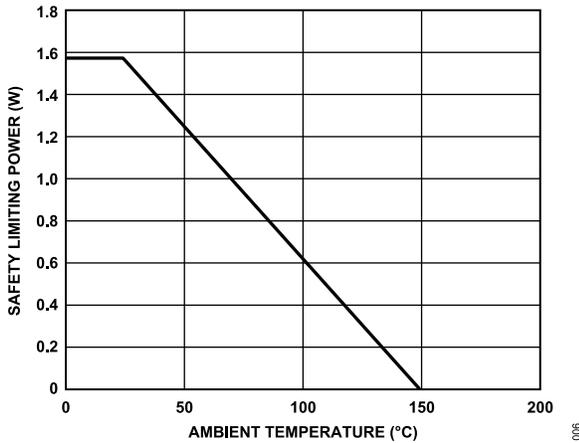


Figure 6. ADuM225N/ADuM226N Thermal Derating Curve, Dependence of Safety Limiting Values with Ambient Temperature per DIN EN IEC 60747-17 (VDE 0884-17)

RECOMMENDED OPERATING CONDITIONS

Table 16.

Parameter	Symbol	Rating
Operating Temperature	T_A	-40°C to +125°C
Supply Voltages	V_{DD1}, V_{DD2}	1.7 V to 5.5 V
Input Signal Rise and Fall Times		1.0 ms

ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 17.

Parameter	Rating
Storage Temperature (T_{ST}) Range	-65°C to $+150^\circ\text{C}$
Ambient Operating Temperature (T_A) Range	-40°C to $+125^\circ\text{C}$
Supply Voltages (V_{DD1} , V_{DD2})	-0.5 V to $+7.0\text{ V}$
Input Voltages (V_{IA} , V_{IB})	-0.5 V to $V_{DD1}^1 + 0.5\text{ V}$
Output Voltages (V_{OA} , V_{OB})	-0.5 V to $V_{DDO}^2 + 0.5\text{ V}$
Average Output Current per Pin ³	
Side 1 Output Current (I_{O1})	-10 mA to $+10\text{ mA}$
Side 2 Output Current (I_{O2})	-10 mA to $+10\text{ mA}$
Common-Mode Transients ⁴	$-150\text{ kV}/\mu\text{s}$ to $+150\text{ kV}/\mu\text{s}$

¹ V_{DD1} is the input side supply voltage.

² V_{DDO} is the output side supply voltage.

³ See Figure 5 or Figure 6 for the maximum rated current values for various temperatures.

⁴ This term refers to the common-mode transients across the insulation barrier. Common-mode transients exceeding the absolute maximum ratings may cause latch-up or permanent damage.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

MAXIMUM CONTINUOUS WORKING VOLTAGE

Table 18. ADuM220N/ADuM221N Maximum Continuous Working Voltage¹

Parameter	Rating	Unit	Applicable Certification
AC Voltage			
Bipolar Waveform	849	V peak	Reinforced insulation rating per IEC 60747-17 (VDE 0884-17)

¹ Maximum continuous working voltage refers to the continuous voltage magnitude imposed across the isolation barrier. See the [Insulation Lifetime](#) section for more details.

Table 19. ADuM225N/ADuM226N Maximum Continuous Working Voltage¹

Parameter	Rating	Unit	Applicable Certification
AC Voltage			
Bipolar Waveform	849	V peak	Reinforced insulation rating per IEC 60747-17 (VDE 0884-17)

¹ Maximum continuous working voltage refers to the continuous voltage magnitude imposed across the isolation barrier. See the [Insulation Lifetime](#) section for more details.

TRUTH TABLE

Table 20. ADuM220N/ADuM221N/ADuM225N/ADuM226N Truth Table (Positive Logic)

V_{IX} Input ^{1,2}	V_{DD1} State ²	V_{DDO} State ²	Default Low (N0), V_{OX} Output ^{1,2,3}	Default High (N1), V_{OX} Output ^{1,2,3}	Test Conditions/Comments
Low	Powered	Powered	Low	Low	Normal operation
High	Powered	Powered	High	High	Normal operation
X ⁴	Unpowered	Powered	Low	High	Fail-safe output
X ⁴	Powered	Unpowered	Indeterminate	Indeterminate	Fail-safe output

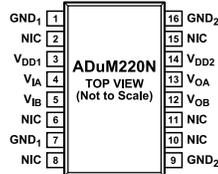
¹ X means don't care.

² V_{IX} and V_{OX} refer to the input and output signals of a given channel (A or B). V_{DD1} and V_{DDO} refer to the supply voltages on the input and output sides of the given channel, respectively.

³ N0 refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the [Ordering Guide](#) section.

⁴ Input pins (V_{IX}) on the same side as an unpowered supply must be in a low state to avoid powering the device through its ESD protection circuitry.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



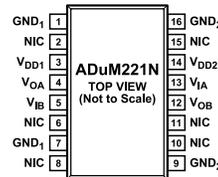
- NOTES
 1. NIC = NO INTERNAL CONNECTION.
 2. PIN 1 AND PIN 7 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND₁ IS RECOMMENDED.
 3. PIN 9 AND PIN 16 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND₂ IS RECOMMENDED.

Figure 7. ADuM220N Pin Configuration

Table 21. ADuM220N Pin Function Descriptions¹

Pin No.	Mnemonic	Description
1	GND ₁	Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND ₁ is recommended.
2	NIC	No Internal Connection. Leave this pin floating.
3	V _{DD1}	Supply Voltage for Isolator Side 1.
4	V _{IA}	Logic Input A.
5	V _{IB}	Logic Input B.
6	NIC	No Internal Connection. Leave this pin floating.
7	GND ₁	Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND ₁ is recommended.
8	NIC	No Internal Connection. Leave this pin floating.
9	GND ₂	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to GND ₂ is recommended.
10	NIC	No Internal Connection. Leave this pin floating.
11	NIC	No Internal Connection. Leave this pin floating.
12	V _{OB}	Logic Output B.
13	V _{OA}	Logic Output A.
14	V _{DD2}	Supply Voltage for Isolator Side 2.
15	NIC	No Internal Connection. Leave this pin floating.
16	GND ₂	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to GND ₂ is recommended.

¹ Reference the AN-1109 Application Note for specific layout guidelines.



- NOTES
 1. NIC = NO INTERNAL CONNECTION.
 2. PIN 1 AND PIN 7 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND₁ IS RECOMMENDED.
 3. PIN 9 AND PIN 16 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND₂ IS RECOMMENDED.

Figure 8. ADuM221N Pin Configuration

Table 22. ADuM221N Pin Function Descriptions¹

Pin No.	Mnemonic	Description
1	GND ₁	Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND ₁ is recommended.
2	NIC	No Internal Connection. Leave this pin floating.
3	V _{DD1}	Supply Voltage for Isolator Side 1.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

Table 22. ADuM221N Pin Function Descriptions¹ (Continued)

Pin No.	Mnemonic	Description
4	V _{OA}	Logic Output A.
5	V _{IB}	Logic Input B.
6	NIC	No Internal Connection. Leave this pin floating.
7	GND ₁	Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND ₁ is recommended.
8	NIC	No Internal Connection. Leave this pin floating.
9	GND ₂	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to GND ₂ is recommended.
10	NIC	No Internal Connection. Leave this pin floating.
11	NIC	No Internal Connection. Leave this pin floating.
12	V _{OB}	Logic Output B.
13	V _{IA}	Logic Input A.
14	V _{DD2}	Supply Voltage for Isolator Side 2.
15	NIC	No Internal Connection. Leave this pin floating.
16	GND ₂	Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to GND ₂ is recommended.

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.



Figure 9. ADuM225N Pin Configuration

Table 23. ADuM225N Pin Function Descriptions¹

Pin No.	Mnemonic	Description
1	V _{DD1}	Supply Voltage for Isolator Side 1.
2	V _{IA}	Logic Input A.
3	V _{IB}	Logic Input B.
4	GND ₁	Ground 1. Ground reference for Isolator Side 1.
5	GND ₂	Ground 2. Ground reference for Isolator Side 2.
6	V _{OB}	Logic Output B.
7	V _{OA}	Logic Output A.
8	V _{DD2}	Supply Voltage for Isolator Side 2.

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.



Figure 10. ADuM226N Pin Configuration

Table 24. ADuM226N Pin Function Descriptions¹

Pin No.	Mnemonic	Description
1	V _{DD1}	Supply Voltage for Isolator Side 1.
2	V _{OA}	Logic Output A.
3	V _{IB}	Logic Input B.
4	GND ₁	Ground 1. Ground reference for Isolator Side 1.
5	GND ₂	Ground 2. Ground reference for Isolator Side 2.
6	V _{OB}	Logic Output B.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS**Table 24. ADuM226N Pin Function Descriptions¹ (Continued)**

Pin No.	Mnemonic	Description
7	V _{IA}	Logic Input A.
8	V _{DD2}	Supply Voltage for Isolator Side 2.

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.

TYPICAL PERFORMANCE CHARACTERISTICS

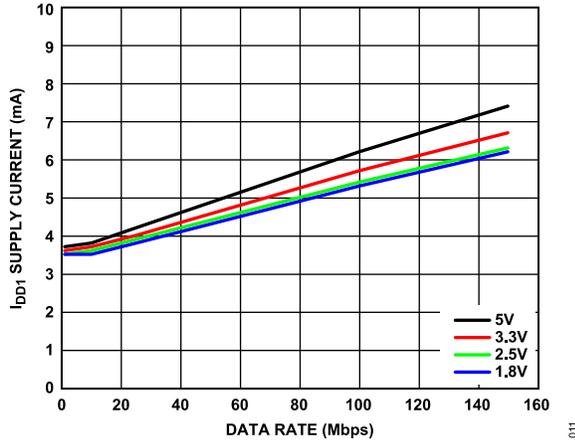


Figure 11. ADuM220N/ADuM225N I_{DD1} Supply Current vs. Data Rate at Various Voltages

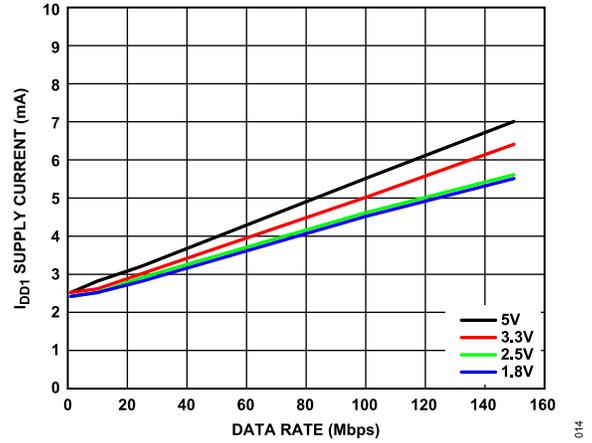


Figure 14. ADuM221N/ADuM226N I_{DD1} Supply Current vs. Data Rate at Various Voltages

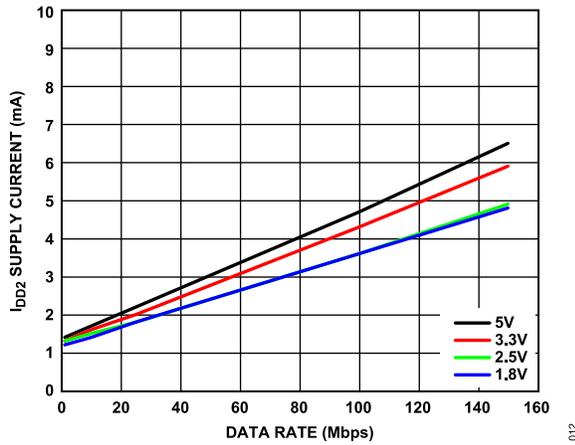


Figure 12. ADuM220N/ADuM225N I_{DD2} Supply Current vs. Data Rate at Various Voltages

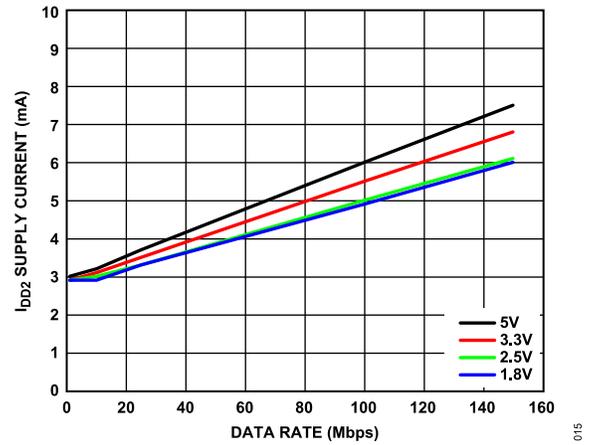


Figure 15. ADuM221N/ADuM226N I_{DD2} Supply Current vs. Data Rate at Various Voltages

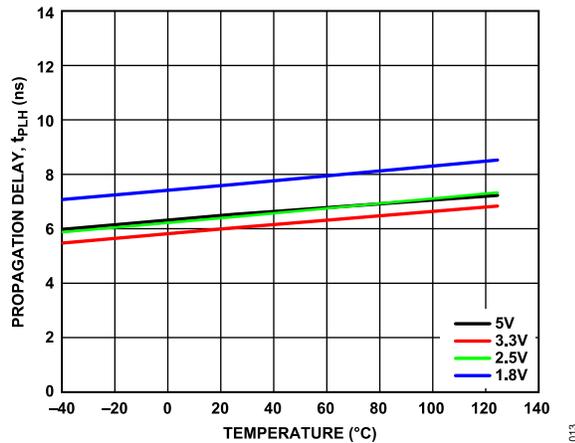


Figure 13. Propagation Delay for Logic High Output (t_{pLH}) vs. Temperature at Various Voltages

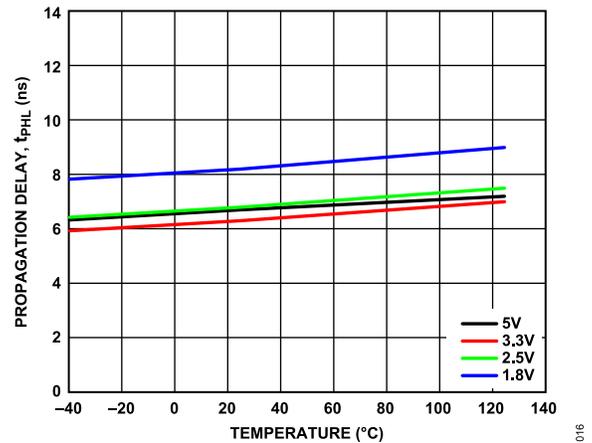


Figure 16. Propagation Delay for Logic Low Output (t_{pHL}) vs. Temperature at Various Voltages

THEORY OF OPERATION

OVERVIEW

The ADuM220N/ADuM221N/ADuM225N/ADuM226N use a high frequency carrier to transmit data across the isolation barrier using iCoupler chip scale transformer coils separated by layers of polyimide isolation. Using an on/off keying (OOK) technique and the differential architecture shown in Figure 17 and Figure 18, the ADuM220N/ADuM221N/ADuM225N/ADuM226N have very low propagation delay and high speed. Internal regulators and input/output design techniques allow logic and supply voltages over a wide range from 1.7 V to 5.5 V, offering voltage translation of 1.8 V, 2.5 V, 3.3 V, and 5 V logic. The architecture is designed for high common-mode transient immunity and high immunity to electrical noise and magnetic interference. Radiated emissions are minimized with a spread spectrum OOK carrier and other techniques.

Figure 17 illustrates the waveforms for models of the ADuM220N/ADuM221N/ADuM225N/ADuM226N that have the condition of the fail-safe output state equal to low, where the carrier waveform is off when the input state is low. If the input side is off or not operating, the fail-safe output state of low (ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models) sets the output to low. For the ADuM220N/ADuM221N/ADuM225N/ADuM226N that have a fail-safe output state of high, Figure 18 illustrates the conditions where the carrier waveform is off when the input state is high. When the input side is off or not operating, the fail-safe output state of high (ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1) sets the output to high. See the Ordering Guide for the model numbers that have the fail-safe output state of low or the fail-safe output state of high.

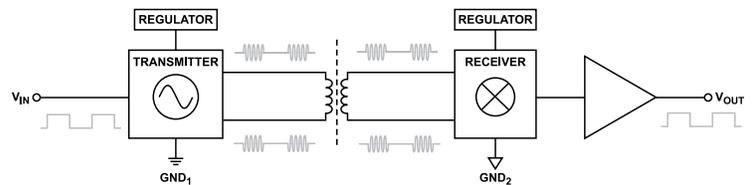


Figure 17. Operational Block Diagram of a Single Channel with a Low Fail-Safe Output State

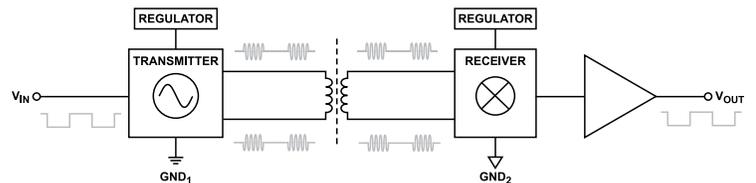


Figure 18. Operational Block Diagram of a Single Channel with a High Fail-Safe Output State

APPLICATIONS INFORMATION

PCB LAYOUT

The ADuM220N/ADuM221N/ADuM225N/ADuM226N digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see [Figure 19](#) and [Figure 20](#)). For the ADuM225N/ADuM226N, bypass capacitors are most conveniently connected between Pin 1 and Pin 4 for V_{DD1} and between Pin 5 and Pin 8 for V_{DD2} . For the ADuM220N/ADuM221N, bypass capacitors are most conveniently connected between Pin 1 and Pin 3 for V_{DD1} and between Pin 14 and Pin 16 for V_{DD2} . The recommended bypass capacitor value is between 0.01 μF and 0.1 μF . The total lead length between both ends of the capacitor and the input power supply pin must not exceed 10 mm. For the ADuM220N/ADuM221N, bypassing between Pin 3 and Pin 7 and between Pin 9 and Pin 14 must also be considered, unless the ground pair on each package side are connected close to the package.

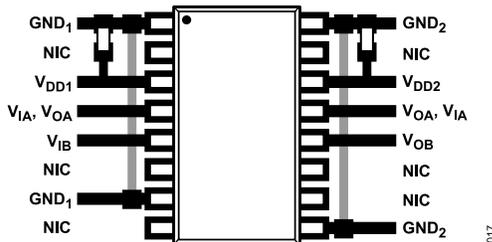


Figure 19. Recommended PCB Layout for ADuM220N/ADuM221N

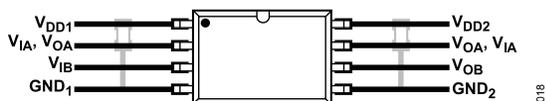


Figure 20. Recommended PCB Layout for ADuM225N/ADuM226N

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, design the board layout such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this can cause voltage differentials between pins exceeding the [Absolute Maximum Ratings](#) of the device, thereby leading to latch-up or permanent damage.

See the [AN-1109 Application Note](#) for board layout guidelines.

PROPAGATION DELAY RELATED PARAMETERS

Propagation delay is a parameter that describes the time it takes a logic signal to propagate through a component. The propagation delay to a Logic 0 output may differ from the propagation delay to a Logic 1 output.

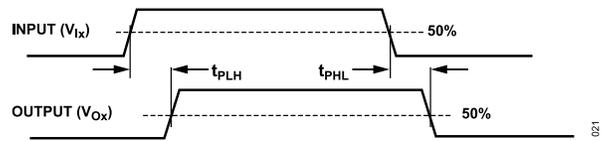


Figure 21. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the timing of the input signal is preserved.

Channel matching is the maximum amount the propagation delay differs between channels within a single ADuM220N/ADuM221N/ADuM225N/ADuM226N component.

Propagation delay skew is the maximum amount the propagation delay differs between multiple ADuM220N/ADuM221N/ADuM225N/ADuM226N components operating under the same conditions.

JITTER MEASUREMENT

[Figure 22](#) shows the eye diagram for the ADuM220N/ADuM221N/ADuM225N/ADuM226N. The measurement was taken using an Agilent 81110A pulse pattern generator at 150 Mbps with pseudorandom bit sequences (PRBS) $2(n-1)$, $n=14$, for 5 V supplies. Jitter was measured with the Tektronix Model 5104B oscilloscope, 1 GHz, 10 GSPS with the DPOJET jitter and eye diagram analysis tools. The result shows a typical measurement on the ADuM220N/ADuM221N/ADuM225N/ADuM226N with 380 ps p-p jitter.

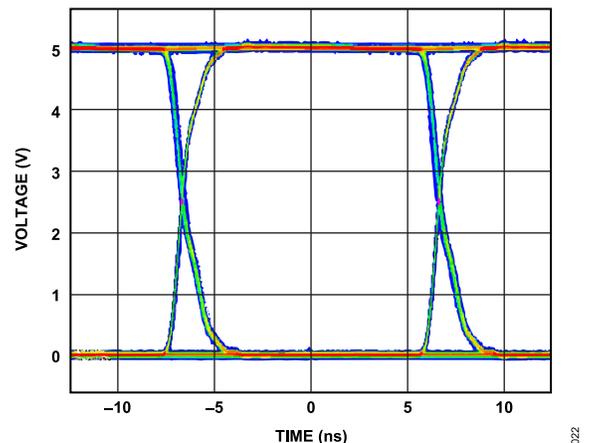


Figure 22. ADuM220N/ADuM221N/ADuM225N/ADuM226N Eye Diagram

INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation as well as on the materials and material interfaces.

APPLICATIONS INFORMATION

The two types of insulation degradation of primary interest are breakdown along surfaces exposed to the air and insulation wear out. Surface breakdown is the phenomenon of surface tracking, and the primary determinant of surface creepage requirements in system level standards. Insulation wear out is the phenomenon where charge injection or displacement currents inside the insulation material cause long-term insulation degradation.

Surface Tracking

Surface tracking is addressed in electrical safety standards by setting a minimum surface creepage based on the working voltage, the environmental conditions, and the properties of the insulation material. Safety agencies perform characterization testing on the surface insulation of components that allows the components to be categorized in different material groups. Lower material group ratings are more resistant to surface tracking and, therefore, can provide adequate lifetime with smaller creepage. The minimum creepage for a given working voltage and material group is in each system level standard and is based on the total rms voltage across the isolation, pollution degree, and material group. The material group and creepage for the ADuM220N/ADuM221N/ADuM225N/ADuM226N isolators are presented in [Table 9](#) and [Table 10](#).

Insulation Wear Out

The lifetime of insulation caused by wear out is determined by its thickness, material properties, and the voltage stress applied. It is important to verify that the product lifetime is adequate at the application working voltage. The working voltage supported by an isolator for wear out may not be the same as the working voltage supported for tracking. It is the working voltage applicable to tracking that is specified in most standards.

Testing and modeling show that the primary driver of long-term degradation is displacement current in the polyimide insulation causing incremental damage. The stress on the insulation can be broken down into broad categories, such as dc stress, which causes very little wear out because there is no displacement current, and an ac component time varying voltage stress, which causes wear out.

The ratings in certification documents are usually based on 60 Hz sinusoidal stress because this reflects isolation from line voltage. However, many practical applications have combinations of 60 Hz ac and dc across the barrier as shown in [Equation 1](#). Because only the ac portion of the stress causes wear out, the equation can be rearranged to solve for the ac rms voltage, as is shown in [Equation 2](#). For insulation wear out with the polyimide materials used in these products, the ac rms voltage determines the product lifetime.

$$V_{RMS} = \sqrt{V_{AC\ RMS}^2 + V_{DC}^2} \quad (1)$$

or

$$V_{AC\ RMS} = \sqrt{V_{RMS}^2 - V_{DC}^2} \quad (2)$$

where:

V_{RMS} is the total rms working voltage.

$V_{AC\ RMS}$ is the time varying portion of the working voltage.

V_{DC} is the dc offset of the working voltage.

Calculation and Use of Parameters Example

The following example frequently arises in power conversion applications. Assume that the line voltage on one side of the isolation is 240 V ac rms and a 400 V dc bus voltage is present on the other side of the isolation barrier. The isolator material is polyimide. To establish the critical voltages in determining the creepage, clearance and lifetime of a device, see [Figure 23](#) and the following equations.

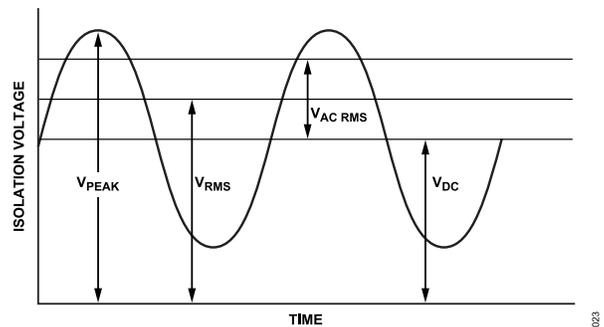


Figure 23. Critical Voltage Example

The working voltage across the barrier from [Equation 1](#) is

$$V_{RMS} = \sqrt{V_{AC\ RMS}^2 + V_{DC}^2}$$

$$V_{RMS} = \sqrt{240^2 + 400^2}$$

$$V_{RMS} = 466\text{ V}$$

This V_{RMS} value is the working voltage used together with the material group and pollution degree when looking up the creepage required by a system standard.

To determine if the lifetime is adequate, obtain the time varying portion of the working voltage. To obtain the ac rms voltage, use [Equation 2](#).

$$V_{AC\ RMS} = \sqrt{V_{RMS}^2 - V_{DC}^2}$$

$$V_{AC\ RMS} = \sqrt{466^2 - 400^2}$$

$$V_{AC\ RMS} = 240\text{ V rms}$$

In this case, the ac rms voltage is simply the line voltage of 240 V rms. This calculation is more relevant when the waveform is not sinusoidal. The value is compared to the limits for the continuous working voltage in [Table 18](#) and [Table 19](#).

Note that the dc working voltage limits in [Table 18](#) and [Table 19](#) are set by the creepage of the package as specified in IEC 60664-1. These values can differ for specific system level standards.

OUTLINE DIMENSIONS

Package Drawing (Option)	Package Type	Package Description
RI-8-1	SOIC_IC	8-Lead Standard Small Outline Package, with Increased Creepage, Wide Body
RW-16	SOIC_W	16-Lead Standard Small Outline Package, Wide Body

For the latest package outline information and land patterns (footprints), go to [Package Index](#).

Updated: November 22, 2023

ORDERING GUIDE

Model ^{1,2}	Temperature Range	Package Description	Packing Quantity	Package Option
ADUM220N0BRWZ	-40°C to +125°C	16-Lead SOIC Wide		RW-16
ADUM220N0BRWZ-RL	-40°C to +125°C	16-Lead SOIC Wide	Reel, 1000	RW-16
ADUM220N1BRWZ	-40°C to +125°C	16-Lead SOIC Wide		RW-16
ADUM220N1BRWZ-RL	-40°C to +125°C	16-Lead SOIC Wide	Reel, 1000	RW-16
ADUM221N0BRWZ	-40°C to +125°C	16-Lead SOIC Wide		RW-16
ADUM221N0BRWZ-RL	-40°C to +125°C	16-Lead SOIC Wide	Reel, 1000	RW-16
ADUM221N0WBRWZ	-40°C to +125°C	16-Lead SOIC Wide		RW-16
ADUM221N0WBRWZ-RL	-40°C to +125°C	16-Lead SOIC Wide	Reel, 1000	RW-16
ADUM221N1BRWZ	-40°C to +125°C	16-Lead SOIC Wide		RW-16
ADUM221N1BRWZ-RL	-40°C to +125°C	16-Lead SOIC Wide	Reel, 1000	RW-16
ADUM225N0BRIZ	-40°C to +125°C	8-Lead SOIC (Increased Creepage)		RI-8-1
ADUM225N0BRIZ-RL	-40°C to +125°C	8-Lead SOIC (Increased Creepage)	Reel, 1500	RI-8-1
ADUM225N1BRIZ	-40°C to +125°C	8-Lead SOIC (Increased Creepage)		RI-8-1
ADUM225N1BRIZ-RL	-40°C to +125°C	8-Lead SOIC (Increased Creepage)	Reel, 1500	RI-8-1
ADUM226N0BRIZ	-40°C to +125°C	8-Lead SOIC (Increased Creepage)		RI-8-1
ADUM226N0BRIZ-RL	-40°C to +125°C	8-Lead SOIC (Increased Creepage)	Reel, 1500	RI-8-1
ADUM226N0WBRIZ	-40°C to +125°C	8-Lead SOIC (Increased Creepage)		RI-8-1
ADUM226N0WBRIZ-RL	-40°C to +125°C	8-Lead SOIC (Increased Creepage)	Reel, 1500	RI-8-1
ADUM226N1BRIZ	-40°C to +125°C	8-Lead SOIC (Increased Creepage)		RI-8-1
ADUM226N1BRIZ-RL	-40°C to +125°C	8-Lead SOIC (Increased Creepage)	Reel, 1500	RI-8-1

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

OUTLINE DIMENSIONS

NO. OF INPUTS, V_{DD1} AND V_{DD2} SIDE OPTIONS

Model ^{1, 2}	No. of Inputs, V_{DD1} Side	No. of Inputs, V_{DD2} Side
ADUM220N0BRWZ	2	0
ADUM220N0BRWZ-RL	2	0
ADUM220N1BRWZ	2	0
ADUM220N1BRWZ-RL	2	0
ADUM221N0BRWZ	1	1
ADUM221N0BRWZ-RL	1	1
ADUM221N0WBRWZ	1	1
ADUM221N0WBRWZ-RL	1	1
ADUM221N1BRWZ	1	1
ADUM221N1BRWZ-RL	1	1
ADUM225N0BRIZ	2	0
ADUM225N0BRIZ-RL	2	0
ADUM225N1BRIZ	2	0
ADUM225N1BRIZ-RL	2	0
ADUM226N0BRIZ	1	1
ADUM226N0BRIZ-RL	1	1
ADUM226N0WBRIZ	1	1
ADUM226N0WBRIZ-RL	1	1
ADUM226N1BRIZ	1	1
ADUM226N1BRIZ-RL	1	1

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications

OUTLINE DIMENSIONS

WITHSTAND VOLTAGE RATING (KV RMS) AND FAIL-SAFE OUTPUT STATE OPTIONS

Model ^{1, 2}	Withstand Voltage Rating (kV rms)	Fail-Safe Output State Options
ADUM220N0BRWZ	5.0	Low
ADUM220N0BRWZ-RL	5.0	Low
ADUM220N1BRWZ	5.0	High
ADUM220N1BRWZ-RL	5.0	High
ADUM221N0BRWZ	5.0	Low
ADUM221N0BRWZ-RL	5.0	Low
ADUM221N0WBRWZ	5.0	Low
ADUM221N0WBRWZ-RL	5.0	Low
ADUM221N1BRWZ	5.0	High
ADUM221N1BRWZ-RL	5.0	High
ADUM225N0BRIZ	5.0	Low
ADUM225N0BRIZ-RL	5.0	Low
ADUM225N1BRIZ	5.0	High
ADUM225N1BRIZ-RL	5.0	High
ADUM226N0BRIZ	5.0	Low
ADUM226N0BRIZ-RL	5.0	Low
ADUM226N0WBRIZ	5.0	Low
ADUM226N0WBRIZ-RL	5.0	Low
ADUM226N1BRIZ	5.0	High
ADUM226N1BRIZ-RL	5.0	High

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The ADuM221N0WBRWZ, ADuM221N0WBRWZ-RL, ADuM226N0WBRIZ, and ADuM226N0WBRIZ-RL models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the [Specifications](#) section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.